

Field Effect Transistor Silicon P/N Channel MOS Type

High Speed Switching Applications

Analog Switch Applications

- Small package
- Low on-resistance Q1: $R_{on} = 4 \Omega$ (max) (@ $V_{GS} = 2.5 V$)
Q2: $R_{on} = 12 \Omega$ (max) (@ $V_{GS} = -2.5 V$)

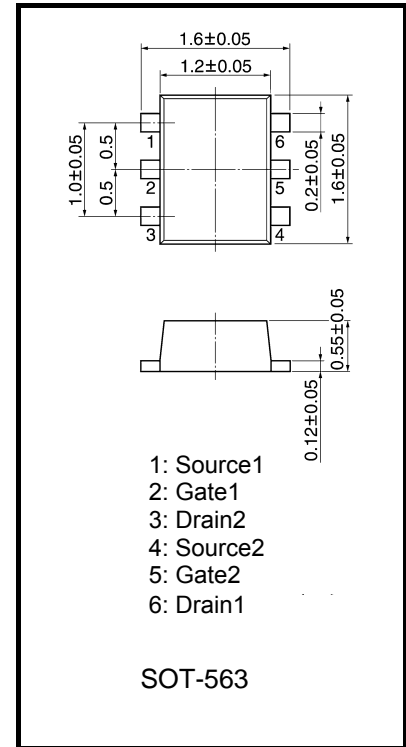
Q1 Absolute Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V_{DS}	20	V
Gate-Source voltage		V_{GSS}	± 10	V
Drain current	DC	I_D	100	mA
	Pulse	I_{DP}	200	

Q2 Absolute Maximum Ratings ($T_a = 25^\circ C$)

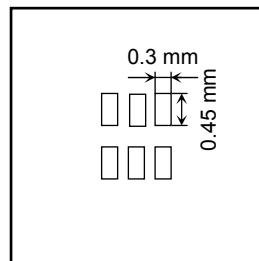
Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V_{DS}	-20	V
Gate-Source voltage		V_{GSS}	± 10	V
Drain current	DC	I_D	-100	mA
	Pulse	I_{DP}	-200	

Unit: mm

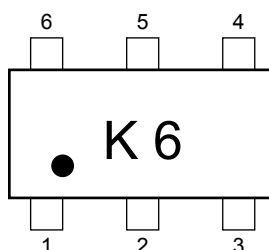


Absolute Maximum Ratings (Q1, Q2 Common) ($T_a = 25^\circ C$)

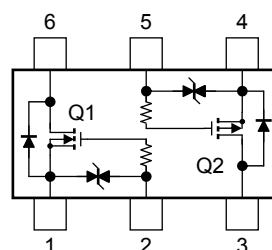
Characteristics	Symbol	Rating	Unit
Drain power dissipation ($T_a = 25^\circ C$)	P_D (Note 1)	150	mW
Channel temperature	T_{ch}	150	$^\circ C$
Storage temperature range	T_{stg}	-55~150	$^\circ C$



Marking



Equivalent Circuit (top view)

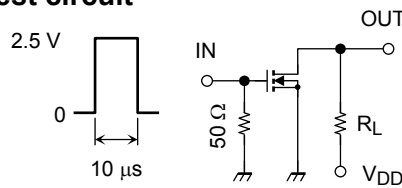


Q1 Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT	
Gate leakage current	I_{GSS}	$V_{GS} = \pm 10\text{ V}, V_{DS} = 0$	—	—	± 1	μA	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = 0.1\text{ mA}, V_{GS} = 0$	20	—	—	V	
Drain cut-off current	I_{DSS}	$V_{DS} = 20\text{ V}, V_{GS} = 0$	—	—	1	μA	
Gate threshold voltage	V_{th}	$V_{DS} = 3\text{ V}, I_D = 0.1\text{ mA}$	0.6	—	1.1	V	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 3\text{ V}, I_D = 10\text{ mA}$	40	—	—	mS	
Drain-Source on-resistance	$R_{DS(ON)}$	$I_D = 10\text{ mA}, V_{GS} = 4\text{ V}$	—	1.5	3.0	Ω	
		$I_D = 10\text{ mA}, V_{GS} = 2.5\text{ V}$	—	2.2	4.0		
		$I_D = 1\text{ mA}, V_{GS} = 1.5\text{ V}$	—	5.2	15		
Input capacitance	C_{iss}	$V_{DS} = 3\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	9.3	—	pF	
Reverse transfer capacitance	C_{rss}		—	4.5	—	pF	
Output capacitance	C_{oss}		—	9.8	—	pF	
Switching time	Turn-on time	t_{on}	$V_{DD} = 3\text{ V}, I_D = 10\text{ mA}, V_{GS} = 0 \sim 2.5\text{ V}$	—	70	—	nS
	Turn-off time	t_{off}		—	125	—	

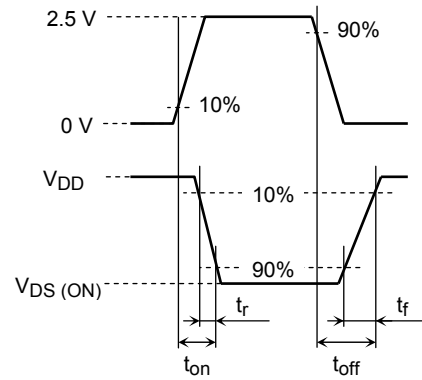
Switching Time Test Circuit

(a) Test circuit



$V_{DD} = 3\text{ V}$
 Duty $\leq 1\%$
 V_{IN} : $t_r, t_f < 5\text{ ns}$
 ($Z_{out} = 50\ \Omega$)
 Common Source
 $T_a = 25^\circ\text{C}$

(b) V_{IN}



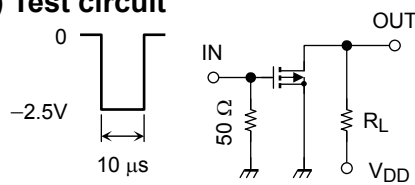
(c) V_{OUT}

Q2 Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT	
Gate leakage current	I_{GSS}	$V_{GS} = \pm 10\text{ V}, V_{DS} = 0$	—	—	± 1	μA	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = -0.1\text{ mA}, V_{GS} = 0$	-20	—	—	V	
Drain cut-off current	I_{DSS}	$V_{DS} = -20\text{ V}, V_{GS} = 0$	—	—	-1	μA	
Gate threshold voltage	V_{th}	$V_{DS} = -3\text{ V}, I_D = -0.1\text{ mA}$	-0.6	—	-1.1	V	
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -3\text{ V}, I_D = -10\text{ mA}$	25	—	—	mS	
Drain-Source on-resistance	$R_{DS(ON)}$	$I_D = -10\text{ mA}, V_{GS} = -4\text{ V}$	—	6	8	Ω	
		$I_D = -10\text{ mA}, V_{GS} = -2.5\text{ V}$	—	8	12		
		$I_D = -1\text{ mA}, V_{GS} = -1.5\text{ V}$	—	18	45		
Input capacitance	C_{iss}	$V_{DS} = -3\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	11	—	pF	
Reverse transfer capacitance	C_{rss}		—	3.7	—	pF	
Output capacitance	C_{oss}		—	10	—	pF	
Switching time	Turn-on time	t_{on}	$V_{DD} = -3\text{ V}, I_D = -10\text{ mA},$ $V_{GS} = 0 \sim -2.5\text{ V}$	—	130	—	ns
	Turn-off time	t_{off}		—	190	—	

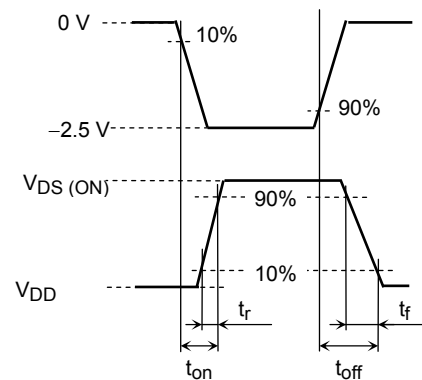
Switching Time Test Circuit

(a) Test circuit

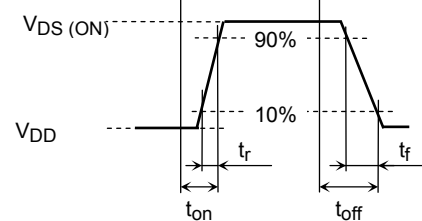


$V_{DD} = -3\text{ V}$
 Duty $\leq 1\%$
 V_{IN} : $t_r, t_f < 5\text{ ns}$
 $(Z_{out} = 50\ \Omega)$
 Common Source
 $T_a = 25^\circ\text{C}$

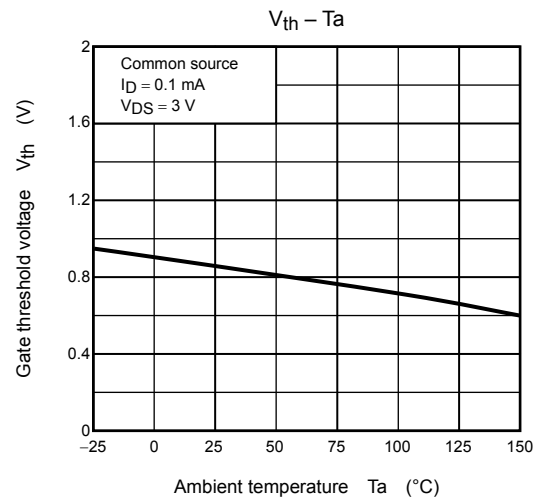
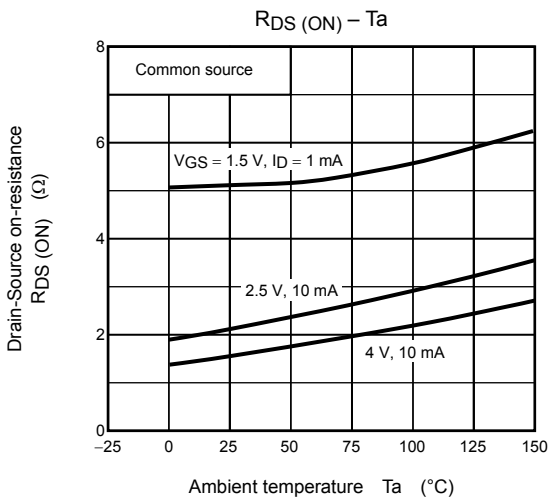
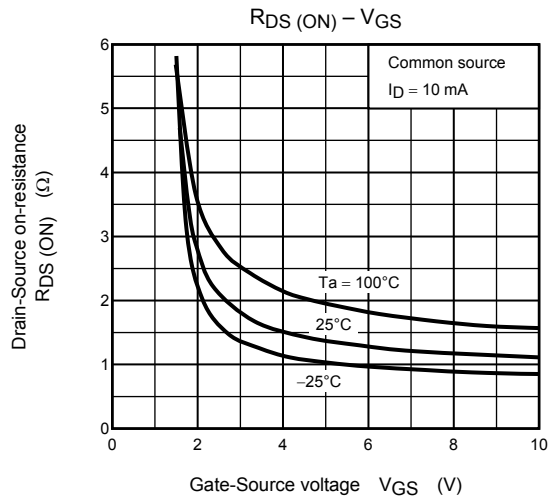
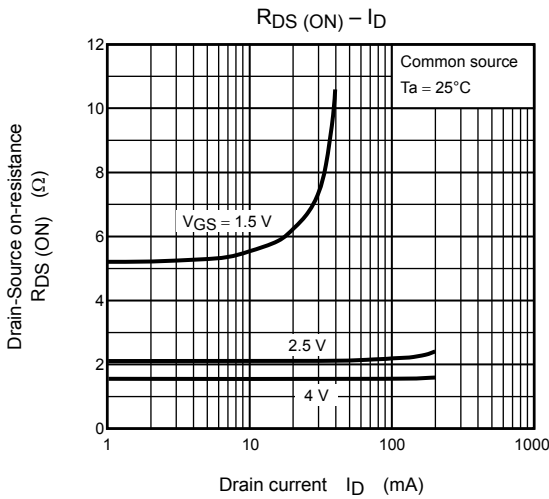
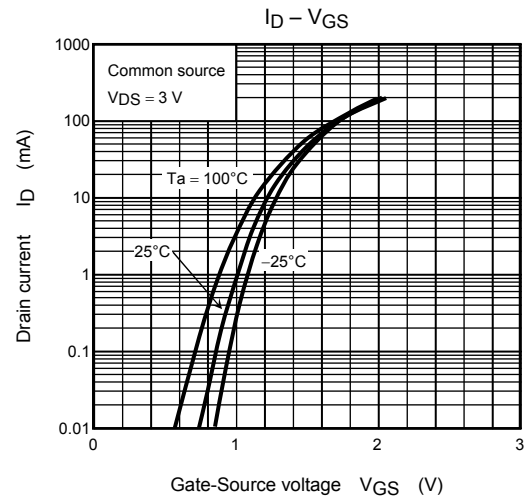
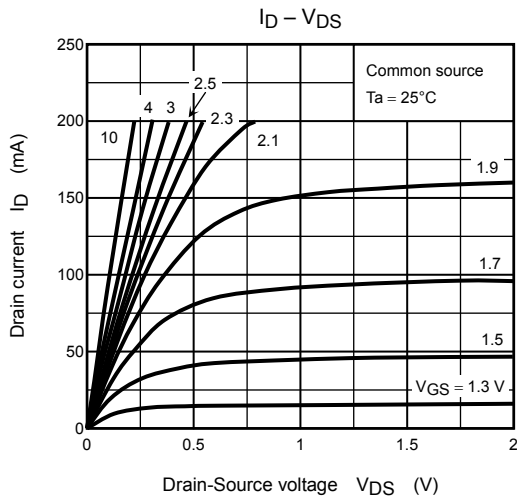
(b) V_{IN}



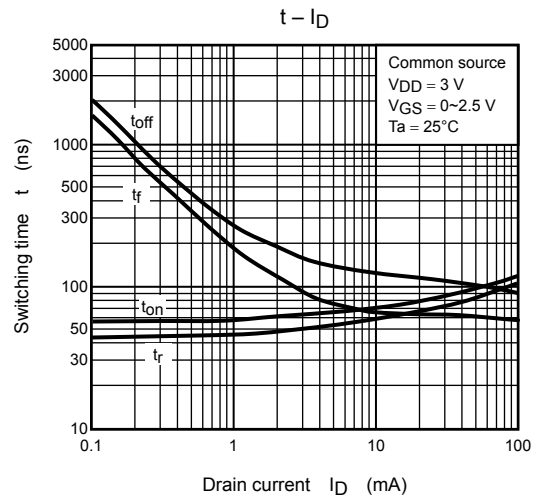
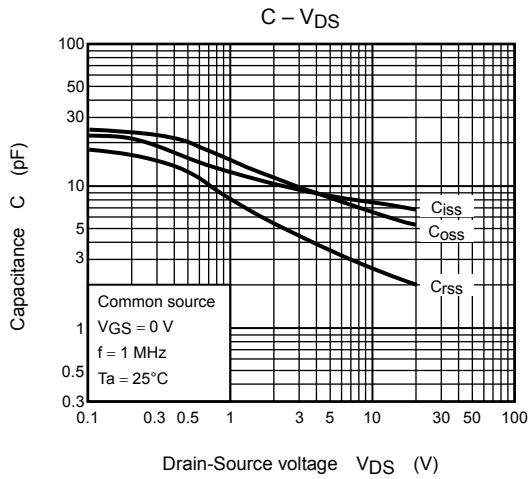
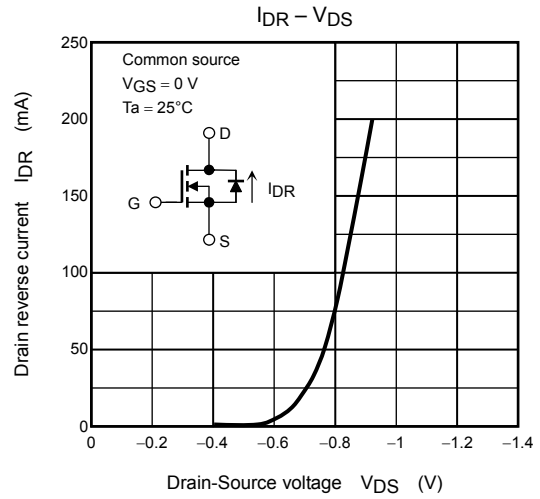
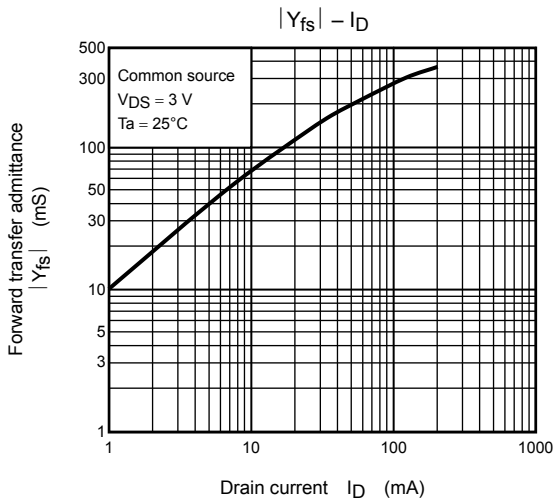
(c) V_{OUT}



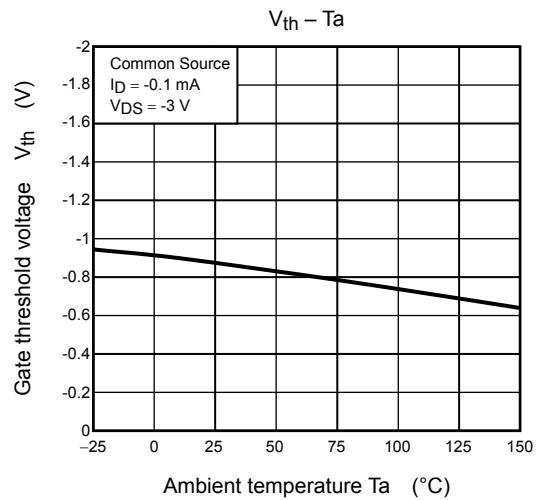
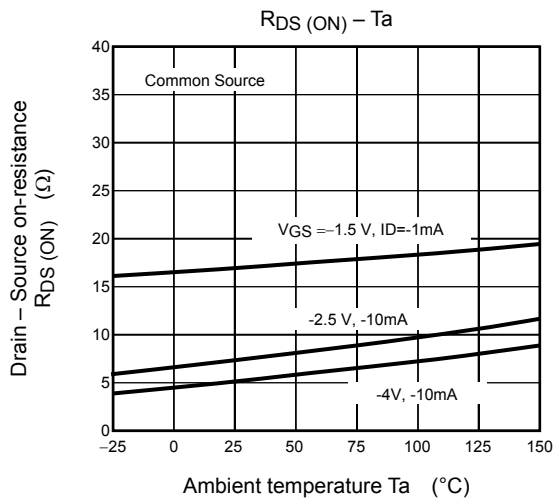
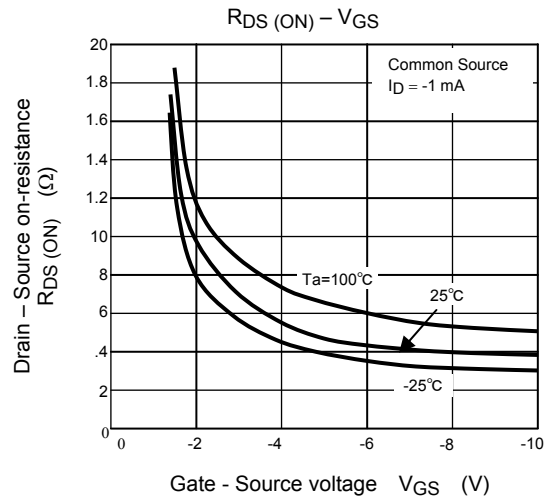
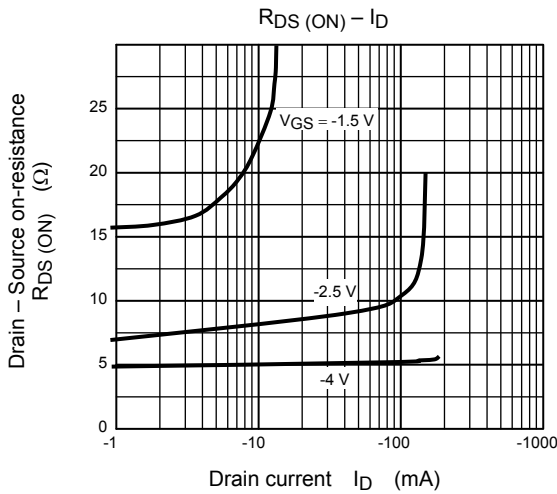
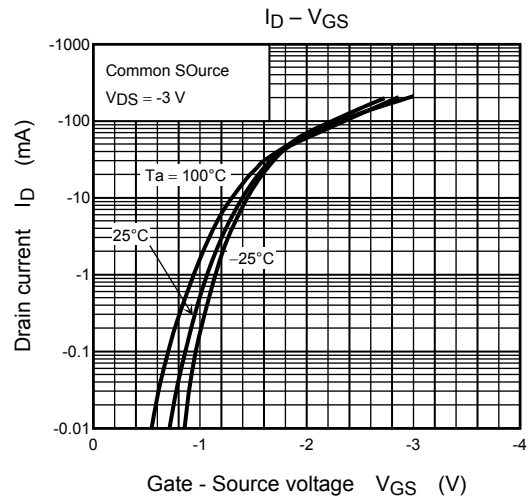
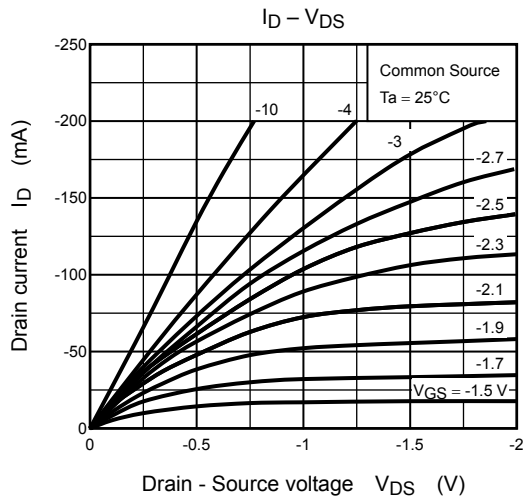
Q1 (N-ch MOSFET)



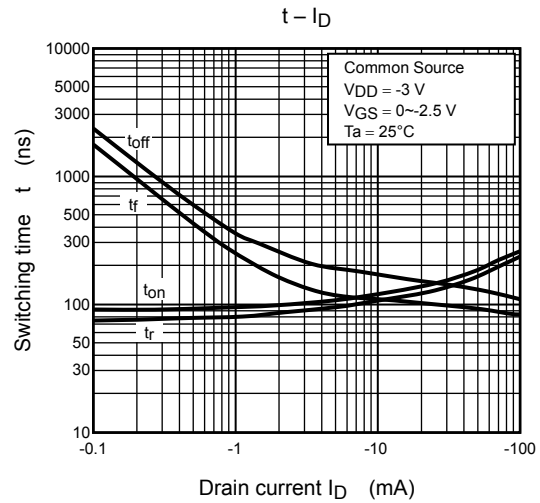
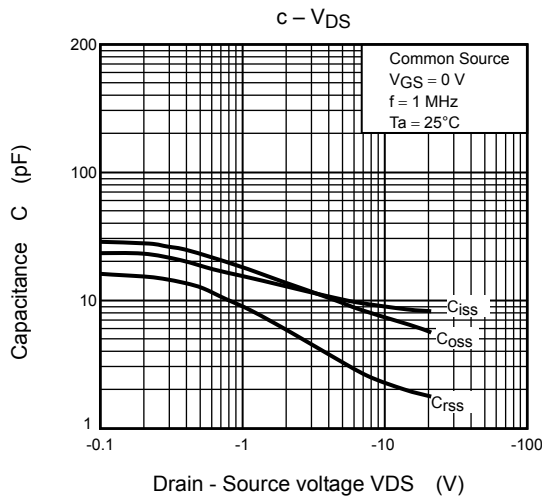
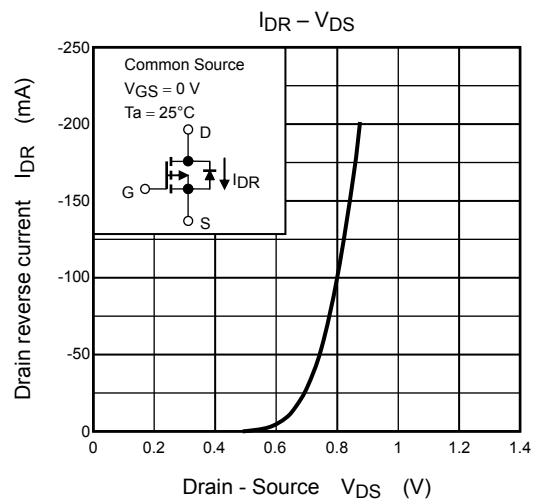
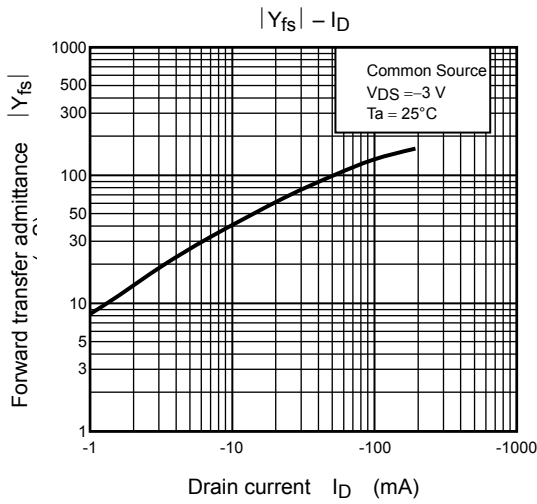
Q1 (N-ch MOSFET)



Q2 (P-ch MOSFET)



Q2 (P-ch MOSFET)



Common Characteristics

